# **N-Channel Shielded Gate POWERTRENCH® MOSFET**

150 V, 85 A, 8.8 mΩ

### **General Description**

This N-Channel MV MOSFET is produced using ON Semiconductor's advanced PowerTrench process that incorporates Shielded Gate technology. This process has been optimized to minimize on-state resistance and yet maintain superior switching performance with best in class soft body diode.

- Shielded Gate MOSFET Technology
- Max  $r_{DS(on)} = 8.8 \text{ m}\Omega$  at  $V_{GS} = 10 \text{ V}$ ,  $I_D = 45 \text{ A}$
- Max  $r_{DS(on)} = 9.4 \text{ m}\Omega$  at  $V_{GS} = 8 \text{ V}$ ,  $I_D = 22.5 \text{ A}$
- Low Qrr, Soft Recovery Body Diode
- Lowers Switching Noise/EMI
- MSL1 Robust Package Design
- 100% UIL Tested
- These Devices are Pb-Free and are RoHS Compliant

### **Applications**

- Primary DC-DC MOSFET
- Synchronous Rectifier in DC-DC and AC-DC
- Motor Drive
- Solar

### MAXIMUM RATINGS (T<sub>A</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-to-Source Voltage	150	V
V <sub>GS</sub>	Gate-to-Source Voltage	±20	V
I <sub>D</sub>		85 54 12.2 340	Α
E <sub>AS</sub>	Single Pulse Avalanche Energy (Note 3)	102	mJ
P <sub>D</sub>	Power Dissipation: T <sub>C</sub> = 25°C T <sub>A</sub> = 25°C (Note 1a)	132 2.7	W
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range	-55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

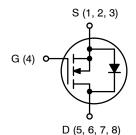
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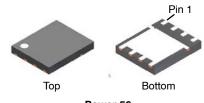
### ON Semiconductor®

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V <sub>DS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
150 V	8.8 mΩ @ 10 V	85 A
150 V	9.4 mΩ @ 8 V	65 A



### **N-CHANNEL MOSFET**



Power 56 (PQFN8) CASE 483AF

### ORDERING INFORMATION

See detailed ordering and shipping information on page 3 of this data sheet.

### THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{ heta JC}$	Thermal Resistance, Junction-to-Case	0.95	°C/W
$R_{ heta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)	46	

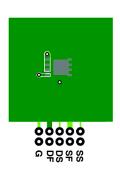
ELECTRIC	CAL CHARACTERISTICS ( $T_J = 25$ °C un	less otherwise noted)				
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHARA	ACTERISTICS					
BV <sub>DSS</sub>	Drain-to-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	150			V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250 μA, referenced to 25°C		86		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 120 V, V <sub>GS</sub> = 0 V			1	μΑ
I <sub>GSS</sub>	Gate-to-Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
ON CHARAC	CTERISTICS					
V <sub>GS(th)</sub>	Gate-to-Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	2.5	3.5	4.5	V
$\Delta V_{GS(th)} / \Delta T_J$	Gate-to-Source Threshold Voltage Temperature Coefficient	I <sub>D</sub> = 250 μA, referenced to 25°C		-7.9		mV/°C
r <sub>DS(on)</sub>	Static Drain-to-Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 45 A		7.0	8.8	mΩ
		V <sub>GS</sub> = 8 V, I <sub>D</sub> = 22.5 A		7.6	9.4	1
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 45 A, T <sub>J</sub> = 125°C		12.8	16.1	
9FS	Forward Transconductance	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 45 A		120	216	S
DYNAMIC C	HARACTERISTICS		•		•	
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 75 V, V <sub>GS</sub> = 0 V, f = 1 MHz		3132	3600	pF
C <sub>oss</sub>	Output Capacitance	7		927	1160	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1		5.3	9.3	pF
R <sub>g</sub>	Gate Resistance			0.73	1.2	Ω
SWITCHING	CHARACTERISTICS		•	•		•
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = 75 \text{ V}, I_D = 45 \text{ A}, V_{GS} = 10 \text{ V},$		23	40	ns
t <sub>r</sub>	Rise Time	$R_{GEN} = 6 \Omega$		19	38	ns
t <sub>d(off)</sub>	Turn-Off Delay Time			30	49	ns
t <sub>f</sub>	Fall Time			5	10	ns
Qg	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V, V <sub>DD</sub> = 75 V, I <sub>D</sub> = 45 A		38	50	nC
Q <sub>gs</sub>	Gate-to-Source Charge	V <sub>DD</sub> = 75 V, I <sub>D</sub> = 45 A		16.4		nC
Q <sub>gd</sub>	Gate-to-Drain "Miller" Charge	V <sub>DD</sub> = 75 V, I <sub>D</sub> = 45 A		5.7		nC
Q <sub>oss</sub>	Output Charge	V <sub>DD</sub> = 75 V, V <sub>GS</sub> = 0 V		101		nC

### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = 25°C unless otherwise noted) (continued)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit	
DRAIN-SOURCE DIODE CHARACTERISTICS							
V <sub>SD</sub>	Source-to-Drain Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 2.2 A (Note 2)		0.73	0.98	V	
		V <sub>GS</sub> = 0 V, I <sub>S</sub> = 45 A (Note 2)		0.88	1.0		
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 45 A, di/dt = 100 A/μs		68	86	ns	
Q <sub>rr</sub>	Reverse Recovery Charge	]		108	172	nC	
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 45 A, di/dt = 1000 A/μs		39	50	ns	
Q <sub>rr</sub>	Reverse Recovery Charge			495	748	nC	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1.  $R_{\theta JA}$  is determined with the device mounted on a 1 in<sup>2</sup> pad 2 oz copper pad on a 1.5  $\times$  1.5 in. board of FR-4 material.  $R_{\theta CA}$  is determined by the user's board design.



a) 46°C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper.



b) 115°C/W when mounted on a minimum pad of 2 oz copper.

- 2. Pulse Test: Pulse Width < 300  $\mu$ s, Duty cycle < 2.0%.
- 3. E<sub>AS</sub> of 102 mJ is based on starting T<sub>J</sub> = 25°C; N-ch: L = 0.1 mH, I<sub>AS</sub> = 45 A, V<sub>DD</sub> = 150 V, V<sub>GS</sub> = 10 V. 100% tested at L = 0.1 mH, I<sub>AS</sub> = 45 A. 4. Pulsed ld please refer to Figure 11 SOA graph for more details. (Note: the final number may change pending results on device characterization).
- 5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

### PACKAGE MARKING AND ORDERING INFORMATION

Device	Marking	Package	Reel Size	Tape Width	Quantity
FDMS8D8N15C	FDMS8D8N15C	Power 56 (PQFN8) (Pb-Free / Halogen Free)	13″	12 mm	3000 units

### TYPICAL CHARACTERISTICS (T<sub>J</sub> = 25°C unless otherwise noted.)

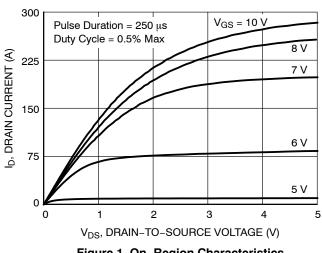


Figure 1. On-Region Characteristics

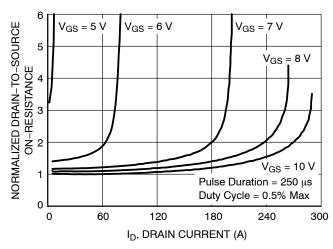


Figure 2. Normalized On-Resistance vs. Drain **Current and Gate Voltage** 

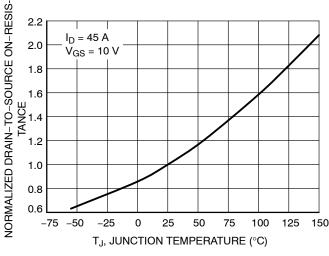


Figure 3. Normalized On-Resistance vs. **Junction Temperature** 

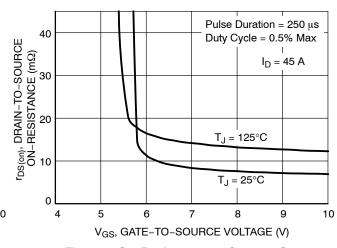


Figure 4. On-Resistance vs. Gate-to-Source Voltage

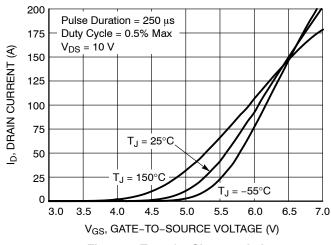


Figure 5. Transfer Characteristics

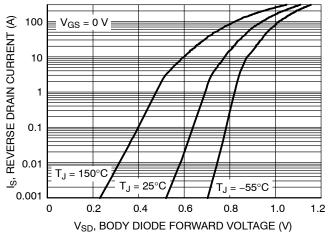


Figure 6. Source-to-Drain Diode Forward Voltage vs. Source Current

## **TYPICAL CHARACTERISTICS** ( $T_J = 25$ °C unless otherwise noted.)

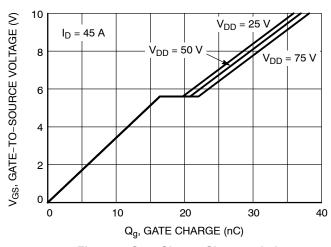


Figure 7. Gate Charge Characteristics

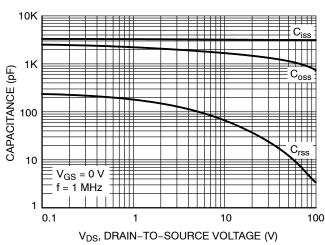


Figure 8. Capacitance vs. Drain-to-Source Voltage

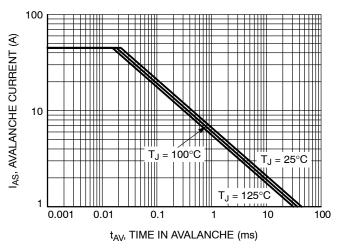


Figure 9. Unclamped Inductive Switching Capability

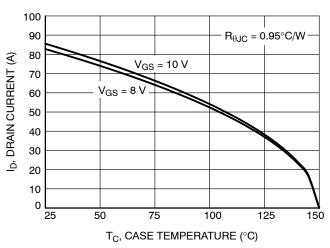


Figure 10. Maximum Continuous Drain Current vs. Case Temperature

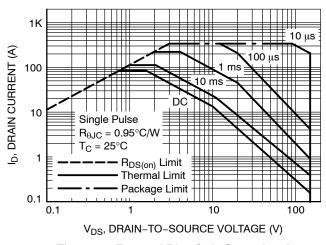


Figure 11. Forward Bias Safe Operating Area

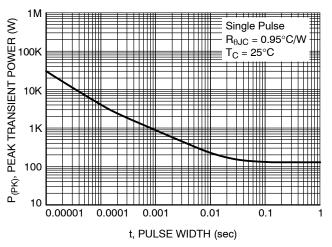


Figure 12. Single Pulse Maximum Power Dissipation

## **TYPICAL CHARACTERISTICS** ( $T_J = 25$ °C unless otherwise noted.)

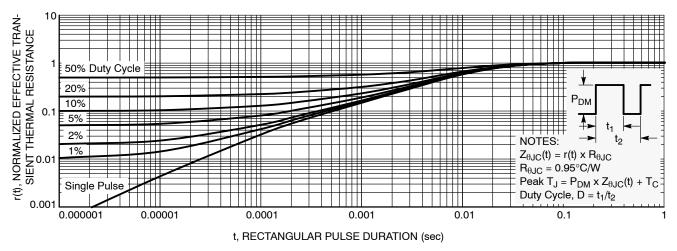
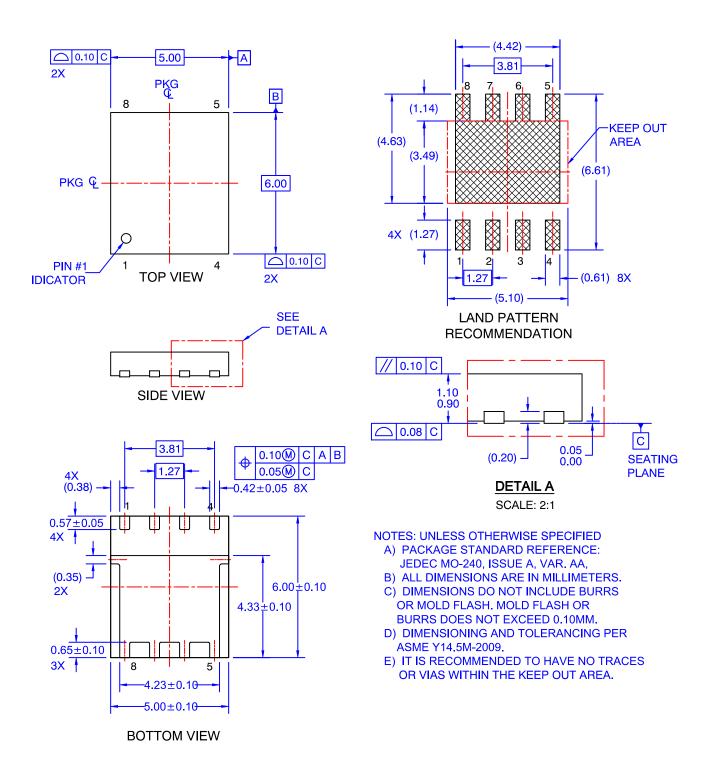


Figure 13. Junction-to-Case Transient Thermal Response Curve

### **PACKAGE DIMENSIONS**

PQFN8 5X6, 1.27P CASE 483AF ISSUE O



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